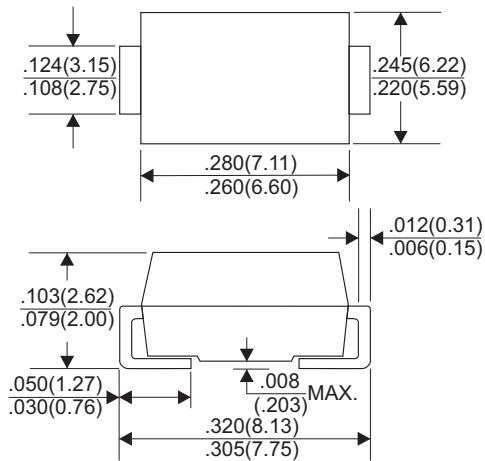




SM820C THER SM8200C

SURFACE MOUNT SCHOTTKY BARRIER RECTIFIERS
Reverse Voltage - 20 to 200 Volts Forward Current - 8.0 Ampere

DO-214AB(SMC)



Dimensions in inches and (millimeters)

FEATURES

- * The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- * For surface mounted applications
- * Metal silicon junction, majority carrier conduction
- * Low power loss, high efficiency
- * Built-in strain relief, ideal for automated placement
- * High forward surge current capability
- * High temperature soldering guaranteed: 250°C/10 seconds at terminals

MECHANICAL DATA

- * Case: Molded plastic
- * Terminals: leads solderable per MIL-STD-750, Method 2026
- * Polarity: Color band denotes cathode end
- * Mounting position: Any

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating 25°C ambient temperature unless otherwise specified.
 Single phase half wave, 60Hz, resistive or inductive load.
 For capacitive load, derate current by 20%.

TYPE NUMBER	SM 820C	SM 830C	SM 840C	SM 850C	SM 860C	SM 880C	SM 8100C	SM 8150C	SM 8200C	UNITS	
Maximum Recurrent Peak Reverse Voltage	20	30	40	50	60	80	100	150	200	V	
Maximum RMS Voltage	14	21	28	35	42	56	70	105	140	V	
Maximum DC Blocking Voltage	20	30	40	50	60	80	100	150	200	V	
Maximum Average Forward Rectified Current											
See Fig. 1										5.0	A
Peak Forward Surge Current, 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)										100	A
Maximum Instantaneous Forward Voltage at 5.0A	0.55		0.70		0.85		0.95			V	
Maximum DC Reverse Current Ta=25°C										0.05	mA
at Rated DC Blocking Voltage Ta=100°C										10	mA
Typical Junction Capacitance (Note 1)										380	pF
Typical Thermal Resistance RθJA (Note 2)										10	°C/W
Operating Temperature Range Tj	-65 — +125			-65 — +150							°C
Storage Temperature Range Tstg										-65 — +150	°C

NOTES:

1. Measured at 1MHz and applied reverse voltage of 4.0V D.C.
2. Thermal Resistance Junction to Ambient Vertical PC Board Mounting 0.5"(12.7mm) Lead Length.

RATING AND CHARACTERISTIC CURVES (SM820C THRU SM8200C)

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

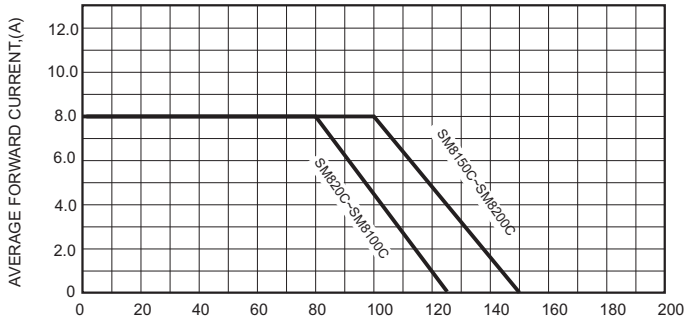


FIG.2-TYPICAL FORWARD CHARACTERISTICS

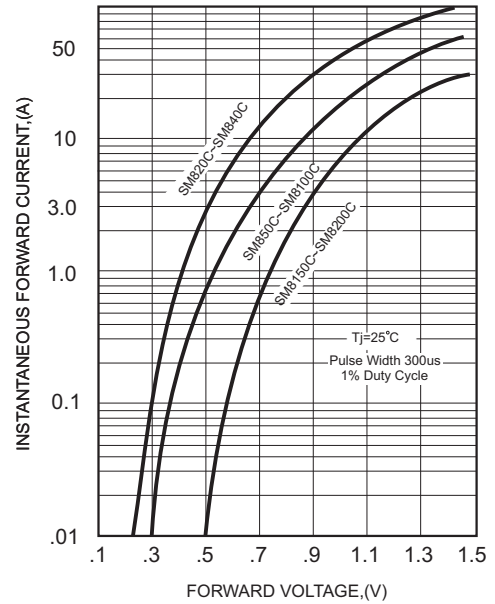


FIG.3-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

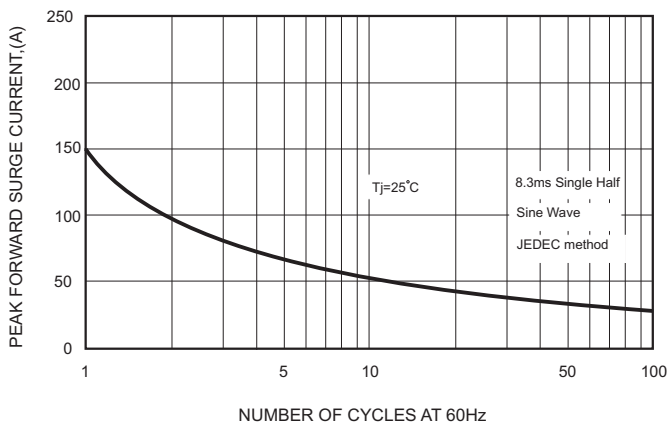


FIG.5 - TYPICAL REVERSE CHARACTERISTICS

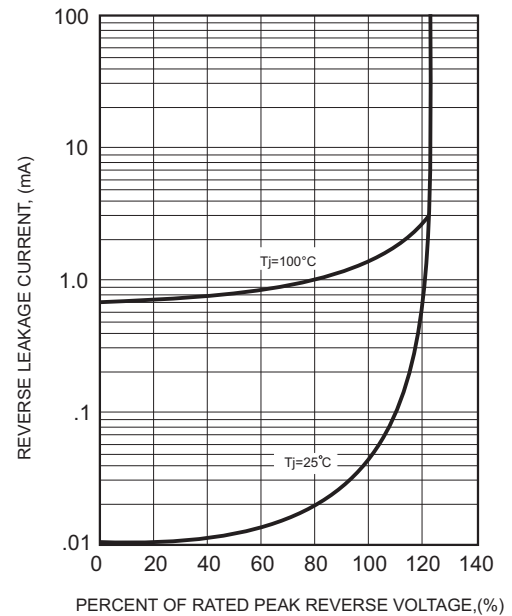


FIG.4-TYPICAL JUNCTION CAPACITANCE

